



Bridgelux® SMD 3838 RGBW 3V

Product Data Sheet DS1422

SMD 3838 RGBW



Introduction

The Bridgelux SMD 3838 low power LED is cold-color targeted, which ensures that the LEDs fall within their specified color bin at the typical application conditions of 25°C. The SMD 3838 is ideal as a drop-in replacement for emitters with an industry standard 3.8mm x 3.8mm footprint.

Features

- Industry-standard 3838 footprint
- · RoHS compliant and lead free
- · RGBW 4 in 1
- · High color gamut
- · RGBW is for decorative lighting
- RGBW color tunable along BBC to mix 2200K-6500K with high CRIgo or CRIg5, and the white CCT meets IEC62471 Risk Group 0

Benefits

- · Lower operating and manufacturing cost
- Ease of design and rapid go-to-market
- Compliant with environmental standards
- · Design flexibility

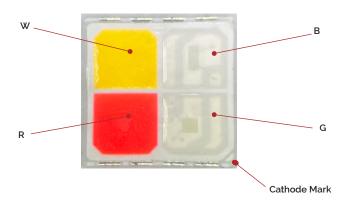


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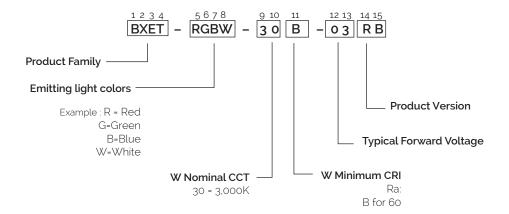
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 3838 RGBW is explained as follows:



Product Test Conditions

Bridgelux SMD 3838 LEDs are tested and binned with a 10ms pulse of 120mA at T_j (junction temperature)= T_{sp} (solder point temperatu

Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, RGB Pulsed Measurement Data at 120mA ($T_i = T_{so} = 25^{\circ}C$)

Part Number³	Color	Nominal Drive Current		Forward Voltage ^{1,2} (V)		Typical Pulsed Flux 1,2	Dominant Wave- length ^{1, 2}	
		(mA)	Min	Typical	Max	(lm)	(nm)	
	Red	120	2.9	3.0	3.1	19.0	618.0	
BXET-RGBW-30B-03RB	Green	120	2.7	2.9	3.0	39.5	524.5	
	Blue	120	3.0	3.1	3.2	8.0	458.5	

Table 2: Selection Guide, W pulsed Measurement Data at 120mA ($T_j = T_{sp} = 25^{\circ}C$)

Part Number	Color	Nominal CCT	CRI	Nominal Drive Current		Forward Voltage ^{1.} (V)	2	Typical Pulsed Flux ^{1, 2}
		(K)		(mA)	Min	Typical	Max	(lm)
BXET-RGBW-30B-03RB	White	3000	60	120	2.9	3.0	3.1	68.0

Table 3: Selection Guide, RGB pulsed Measurement Data at 120mA ($T_j = T_{sp} = 85^{\circ}C$)

Part Number	Color	Nominal Drive Current	F	orward Voltage¹ (V)	Typical Pulsed Flux ^{1, 2}	Dominant Wave- length ^{1, 2}		
		(mA)	Min	Typical	Max	(lm)	(nm)	
	Red	120	2.8	2.9	3.0	17.0	617.5	
BXET-RGBW-30B-03RB	Green	120	2.6	2.8	2.9	35.2	527.0	
	Blue	120	2.9	3.0	3.1	8.0	460.5	

Table 4: Selection Guide, W pulsed Measurement Data at 120mA (T_i=T_{sp}=85°C)

Part Number	Color	Nominal CCT (K)	CRI	Nominal Drive Current	F	Typical Pulsed Flux ^{1,2}			
		(IV)		(mA)	Min	Typical	Max	(lm)	
BXET-RGBW-30B-03RB	White	3000	60	120	2.8	2.9	3.0	62.4	

Notes for Tables 1, 2, 3 and 4:

- 1. Products tested under pulsed condition (10ms pulse width) at nominal drive current.
- 2. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±1nm tolerance on dominant wavelength measurements for SMD 3838.
- 3. Refer to Tables 12, 13 and 14 for Bridgelux SMD 3838 flux Binning and Forward Voltage Binning and Dominant Wavelength Binning information.

Product Selection Guide

Table 5: Selection Guide, Tunable White with CRIgo ($T_{\rm sp}$ =25°C)

Power	сст	W ratio	R ratio	G ratio	B ratio	W Drive Current (mA)	R Drive Current (mA)	G Drive Current (mA)	B Drive Current (mA)	CIE-X	CIE-Y	CRI	R9	Power (w)	Flux (lm)	Efficacy (lm/w)
	1800	35.34%	64.29%	0.38%	0.00%	53.0	96.4	0.6	0.0	0.5473	0.4015	92.7	64.5	0.427	47.5	111.3
	2200	49.41%	47.93%	1.65%	1.01%	74.1	71.9	2.5	1.5	0.5047	0.4154	93.6	58.4	0.422	57.1	135.4
	2700	54.61%	36.42%	5.31%	3.67%	81.9	54.6	8.0	5.5	0.4600	0.4109	93.1	59.6	0.415	62.7	150.9
	3000	55.34%	31.07%	7.93%	5.66%	83.0	46.6	11.9	8.5	0.4347	0.4036	93.1	61.9	0.412	64.5	156.7
0.5W	3500	55.49%	25.57%	10.70%	8.24%	83.2	38.4	16.0	12.4	0.4081	0.3907	93.4	63.1	0.409	65.8	161.0
	4000	53.31%	20.93%	14.69%	11.06%	80.0	31.4	22.0	16.6	0.3806	0.3797	93.3	65.4	0.403	66.4	165.0
	5000	49.40%	14.83%	19.73%	16.04%	74.1	22.2	29.6	24.1	0.3428	0.3540	93.1	65.9	0.399	65.2	163.3
	5700	47.42%	12.39%	21.31%	18.89%	71.1	18.6	32.0	28.3	0.3257	0.3394	93.1	68.1	0.398	64.7	162.5
	6500	44.73%	10.33%	23.46%	21.48%	67.1	15.5	35.2	32.2	0.3095	0.3254	93.3	70.3	0.396	63.4	160.0

Table 6: Selection Guide, Tunable White with CRI90 ($T_{\rm sp}$ =85°C)

Power	сст	W ratio	R ratio	G ratio	B ratio	W Drive Current (mA)	R Drive Current (mA)	G Drive Current (mA)	B Drive Current (mA)	CIE-X	CIE-Y	CRI	R9	Power (w)	Flux (lm)	Efficacy (lm/w)
	1800	35.34%	64.29%	0.38%	0.00%	53.0	96.4	0.6	0.0	0.5423	0.4020	93.6	63.2	0.422	43.9	104.1
	2200	49.41%	47.93%	1.65%	1.01%	74.1	71.9	2.5	1.5	0.5012	0.4148	92.5	55.8	0.417	52.8	126.6
	2700	54.61%	36.42%	5.31%	3.67%	81.9	54.6	8.0	5.5	0.4583	0.4101	91.9	58.5	0.412	57.9	140.8
	3000	55.34%	31.07%	7.93%	5.66%	83.0	46.6	11.9	8.5	0.4340	0.4028	91.9	58.6	0.409	59.6	145.7
0.5W	3500	55.49%	25.57%	10.70%	8.24%	83.2	38.4	16.0	12.4	0.4077	0.3915	91.8	59.2	0.406	60.8	149.5
	4000	53.31%	20.93%	14.69%	11.06%	80.0	31.4	22.0	16.6	0.3817	0.3798	91.9	61.7	0.402	61.4	152.8
	5000	49.40%	14.83%	19.73%	16.04%	74.1	22.2	29.6	24.1	0.3451	0.3553	91.9	61.1	0.399	60.4	151.2
	5700	47.42%	12.39%	21.31%	18.89%	71.1	18.6	32.0	28.3	0.3285	0.3416	91.9	63.1	0.399	59.6	149.3
	6500	44.73%	10.33%	23.46%	21.48%	67.1	15.5	35.2	32.2	0.3126	0.3281	91.9	65.8	0.397	58.8	148.1

Product Selection Guide

Table 7: Selection Guide, Tunable White with CRI95 ($T_{\rm sp}$ =25°C)

Power	сст	W ratio	R ratio	G ratio	B ratio	W Drive Current (mA)	R Drive Current (mA)	G Drive Current (mA)	B Drive Current (mA)	CIE-X	CIE-Y	CRI	R9	Power (w)	Flux (lm)	Efficacy (lm/w)
	2200	41.01%	53.07%	4.75%	1.17%	61.5	79.6	7.1	1.8	0.5041	0.4156	94.5	80.4	0.415	54.5	131.4
	2700	48.17%	40.53%	7.59%	3.71%	72.3	60.8	11.4	5.6	0.4596	0.4107	96.1	77.9	0.411	60.5	147.3
	3000	47.79%	35.84%	10.82%	5.54%	71.7	53.8	16.2	8.3	0.4344	0.4042	96.1	84.2	0.407	61.9	151.9
0.5W	3500	48.12%	30.17%	13.66%	8.04%	72.2	45.3	20.5	12.1	0.4072	0.3923	96.2	86.0	0.403	63.2	156.9
0.5W	4000	46.27%	25.61%	17.42%	10.70%	69.4	38.4	26.1	16.1	0.3803	0.3796	96.0	89.9	0.400	63.5	158.6
	5000	42.33%	19.58%	22.64%	15.45%	63.5	29.4	34.0	23.2	0.3420	0.3540	95.4	93.9	0.396	62.2	157.0
	5700	39.20%	18.60%	24.40%	17.80%	58.8	27.9	36.6	26.7	0.3260	0.3399	94.3	92.9	0.394	61.1	155.0
	6500	36.79%	16.08%	26.68%	20.45%	55.2	24.1	40.0	30.7	0.3088	0.3254	94.2	90.9	0.393	59.8	152.1

Table 8: Selection Guide, Tunable White with CRI95 ($T_{\rm sp}$ =85°C)

Power	сст	W ratio	R ratio	G ratio	B ratio	W Drive Current (mA)	R Drive Current (mA)	G Drive Current (mA)	B Drive Current (mA)	CIE-X	CIE-Y	CRI	R9	Power (w)	Flux (lm)	Efficacy (lm/w)
	2200	41.01%	53.07%	4.75%	1.17%	61.5	79.6	7.1	1.8	0.5011	0.4149	95.6	76.3	0.413	50.3	121.9
	2700	48.17%	40.53%	7.59%	3.71%	72.3	60.8	11.4	5.6	0.4583	0.4100	95.8	73.6	0.407	56.0	137.4
	3000	47.79%	35.84%	10.82%	5.54%	71.7	53.8	16.2	8.3	0.4339	0.4035	96.2	79.1	0.404	57.2	141.5
0.5\\/	3500	48.12%	30.17%	13.66%	8.04%	72.2	45.3	20.5	12.1	0.4076	0.3920	96.1	80.8	0.401	58.5	145.9
0.5W	4000	46.27%	25.61%	17.42%	10.70%	69.4	38.4	26.1	16.1	0.3817	0.3798	96.0	84.4	0.399	58.7	147.2
	5000	42.33%	19.58%	22.64%	15.45%	63.5	29.4	34.0	23.2	0.3446	0.3553	95.8	87.7	0.397	57.6	145.3
	5700	39.20%	18.60%	24.40%	17.80%	58.8	27.9	36.6	26.7	0.3290	0.3417	95.6	96.5	0.394	56.6	143.4
	6500	36.79%	16.08%	26.68%	20.45%	55.2	24.1	40.0	30.7	0.3123	0.3280	95.3	95.8	0.394	55.4	140.7

Performance at Commonly Used Drive Currents

SMD 3838 RGBW specifications at nominal drive current are shown in Tables 1 & 2. SMD 3838 RGBW may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 9.

Table 9: Performance at Commonly Used Drive Currents

Part Number	Color	Drive Current¹ (mA)	Typical Voltage T _{sp} =25°C (V)	Typical Pulsed Flux² T _{sp} =25°C (lm)	Typical Pulsed Flux² T _{sp} =85°C (lm)					
		30	2.7	5.3	4.9					
		60	2.8	10.2	9.3					
	Red	90	2.9	14.8	13.4					
		120	3.0	19.0	17.0					
		160	3.1	24.2	21.3					
		30	2.4	14.8	13.3					
		60	2.6	25.0	22.4					
	Green	90	2.8	32.9	29.4					
		120	2.9	39.5	35.2					
BXET-RGBW-30B-03RB		160	3.0	46.7	41.3					
BACT NODW 30D 03ND		30	2.7	2.6	2.7					
		60	2.9	4.7	4.7					
	Blue	90	3.0	6.4	6.5					
			120	3.1	8.0	8.0				
		160	3.2	9.9	9.8					
		30	2.7	18.4	17.3					
								60	2.8	35.8
	White	90	2.9	52.2	48.3					
		120	3.0	68.0	62.4					
		160	3.1	87.7	79.7					

Notes for Table 9:

- 1. Alternate drive currents in Table 9 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
- 3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Electrical and Thermal Characteristics

Table 10: Electrical and Thermal Characteristics

			Fo	rward Voltage (V)	e ^{1,2}	Typical Temperature Coefficient	Typical Thermal Resistance
Part Number	Color	Drive Current (mA)	Minimum	Typical	Maximum	of Forward Voltage³ △V,/△T (mV/°C)	Junction to Solder Point ⁴ R _{j-sp} (°C/W)
	Red	120	2.9	3.0	3.1	-1.1	32.5
DVCT DODW D	Green	120	2.7	2.9	3.0	-1.1	80.0
BXET-RGBW-30B-03RB	Blue	120	3.0	3.1	3.2	-1.0	40.0
	White	120	2.9	3.0	3.1	-1.1	28.5

Notes for Table 10:

- 1. Products tested under pulsed condition (10ms pulse width) where $T_{\rm sp}$ = 25 $^{\circ}$ C.
- 2. Bridgelux maintains a tolerance of \pm 0.1V on forward voltage measurements.
- 3. Products measured between 25°C and 85°C under pulsed condition (10ms pulse width).
- 4. Thermal resistance value was calculated using total electrical input power, optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 11: Maximum Ratings

Parameter		Maximui	m Rating			
LED Junction Temperature (T _j)		125	S°C			
Storage Temperature		-40°C to) +105°C			
Operating Solder Point Temperature (T _{Sp})		-40°C to) +105°C			
Soldering Temperature	2	60°C or lower for a m	aximum of 10 second	ls		
	R	G	В	W		
DC Forward Current(single color light)	160mA	160mA	160mA	160mA		
Peak Pulsed Forward Current ¹	200mA	200mA	200mA	200mA		
Maximum Power		1\	W.			
Maximum Reverse Voltage²		[;V			
Moisture Sensitivity Rating		MS	L3			
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012					

Notes for Table 11:

^{1.} Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating SMD 3838 at maximum peak pulsed current specified. Maximum peak pulsed currents indicate values where SMD 3838 can be driven without catastrophic failures.

^{2.} Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. Maximum rating provided for reference only.

Product Bin Definitions

Table 12 lists the standard photometric luminous flux bins for SMD 3838 RGBW. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance.

Table 12: Luminous Flux Bin Definitions at 120mA, T_{sp} =25°C

Color	Bin Code	Lumino	us Flux¹	Unit	Condition
Color		Minimum	Maximum	Onit	
R	R9	14	27		I _F =120mA
G	G7	32	53	lm	
В	B1	6	10	ł lm	
W	W9	57	83		

Note for Table 12:

Table 13: Forward Voltage Bin Definitions at 120mA, T_{sp} =25 $^{\circ}$ C

Color	Bin Code	Forward	Voltage ¹	Unit	Condition
Cotor		Minimum	Maximum	Onit	
R/G/B/W	B2	2.7	2.8		I _F =120mA
	B3	2.8	2.9		
	B4	2.9	3.0	V	
	B5	3.0	3.1		
	В6	3.1	3.2		

Note for Table 13:

Table 14: Dominant Wavelength Bin Definitions at 120mA, T_{sp}=25°C

Color	Bin Code	Dominant W	Vavelength ¹	Unit	Condition
Color		Minimum	Maximum	Onit	
В	Р	455	460		I _F =120mA
В	Q	460	465		
G	G	520	525	- nm	
G	Н	525	530		

Note for Table 14:

^{1.} Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

^{1.} Bridgelux maintains a tolerance of \pm 0.1V on forward voltage measurements.

^{1.} Bridgelux maintains a tolerance of \pm 1nm on dominant wavelength measurements.

Product Bin Definitions

Table 15: R&W MacAdam Ellipse Color Bin Definitions (T_{sp} =25°C)

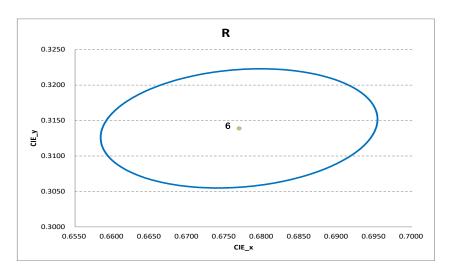
Color	or Color Space	Center Point		Major Axis	Minor Axis	Ellipse Rotation	Color Bin
Cotor		х	Υ	Major Axis	MINOI AXIS	Angle	COLOI BIII
R	6 Step	0.6769	0.3139	0.01854	0.00828	5.0	6
W	3 Step	0.4520	0.4630	0.00834	0.00408	53.22	3
W	6 Step	0.4530	0.4030	0.01638	0.00816	53.22	3/A/B/C/D

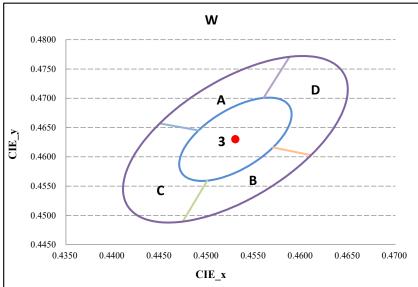
Notes for Table 15:

- 1. Color binning at T_{sp}=25°C unless otherwise specified.
- 2. Bridgelux maintains a tolerance of ± 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (Color Bin Structure, T_{sp} =25°C)





Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=25°C)

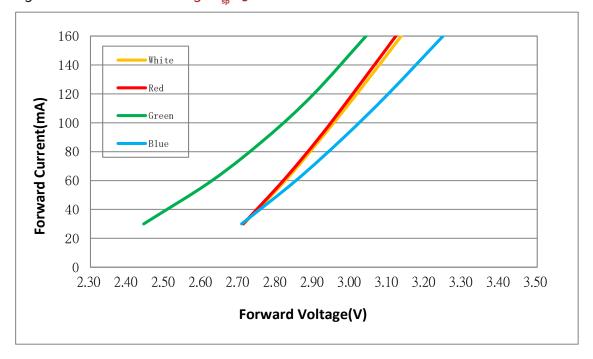
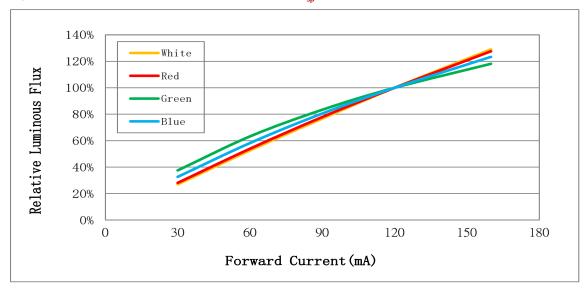


Figure 3: Relative Luminous Flux vs. Drive Current (T_{sp}=25°C)



Note for Figure 3:

1. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Relative Flux vs. Solder Point Temperature_120mA

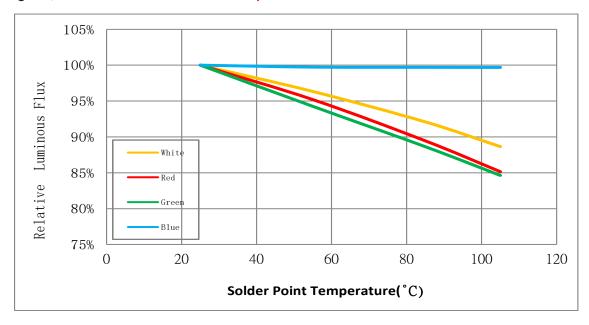
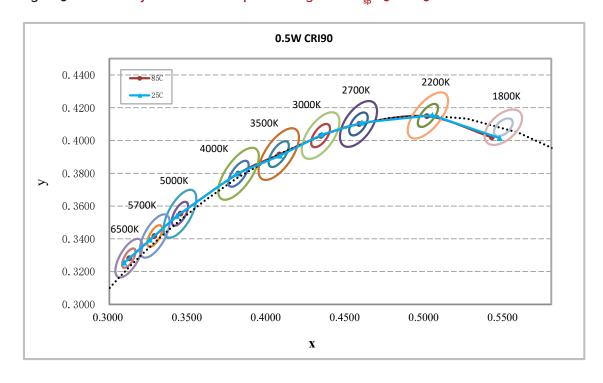
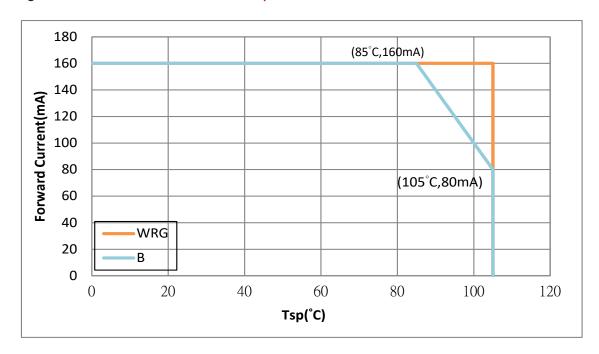


Figure 5: Chromaticity Coordinate Group(Color Targeted at T_{sp}=25°C & 85°C)



Performance Curves

Figure 6: Drive Current vs Solder Point Temperature



Typical Radiation Pattern

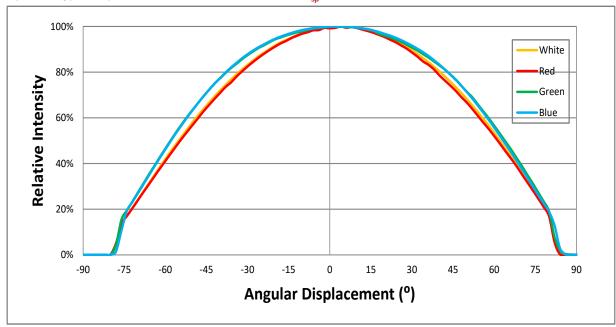


Figure 7: Typical Spatial Radiation Pattern at 120mA, T_{sp}=25°C

Notes for Figure 7:

- 1. W&R typical viewing angle is 116°, G&B typical viewing angle is 122°.
- 2. The viewing angle is defined as the off axis angle from the centerline where lv is $\frac{1}{2}$ of the peak value.

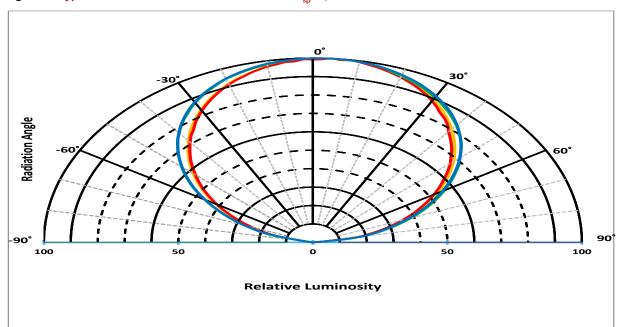


Figure 8: Typical Polar Radiation Pattern at 120mA, T_{sp}=25°C

Typical Color Spectrum

Figure 9: Typical Color Spectrum at 120mA, Tsp=25°C

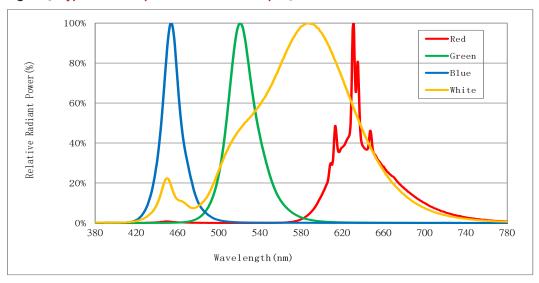
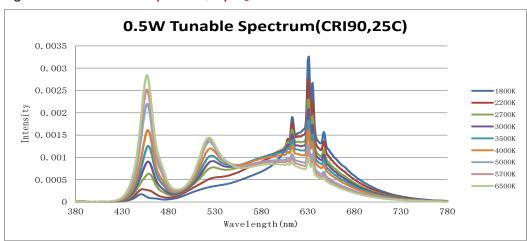
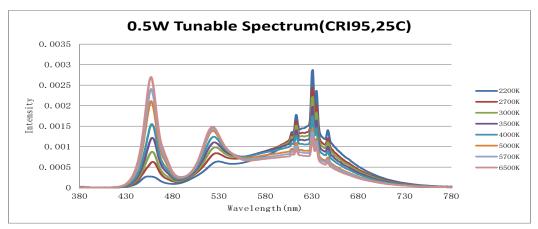


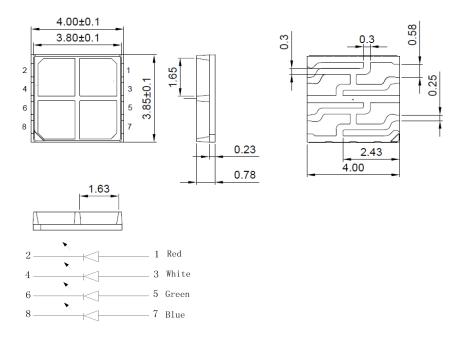
Figure 10: Tunable White Spectrum, Tsp=25°C





Mechanical Dimensions

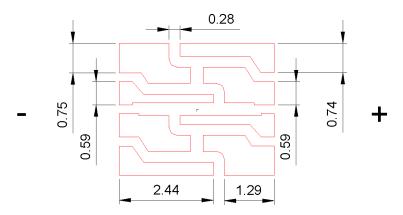
Figure 11: Drawing for SMD 3838



Notes for Figure 11:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are ± 0.10mm.
- 4. The optical center of the LED emitter is nominally defined by the mechanical center of the emitter. The light emitting surface (LES) is centered on the mechanical center of the LED emitter to a tolerance of ± 0.2 mm

Recommended PCB Soldering Pad Pattern



Reliability

Table 16: Reliability Test Items and Conditions

No.	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture Sensitivity Level	J-STD-020D.1	T _{std} = 260°C, 10sec, Precondition: 85°C, 60%RH, 168hr		3 reflows	0/22
2	Low Temperature Storage	JESD22-A119	T _a =-40°C		1000 hours	0/22
3	High Temperature Storage	JESD22-A103	T _a =105°C		1000 hours	0/22
4	Low Temperature Operating Life	JESD22-A108	T _a =-40°C	120mA	1000 hours	0/22
5	Temperature Humidity Operating Life	JESD22-A101	T _{sp} =85°C, RH=85%	120mA	1000 hours	0/22
6	High Temperature Operating Life	JESD22-A108	T _{sp} =105°C, RGBW 4 channel all on	120mA	1000 hours	0/22
7	High Temperature Operating Life	JESD22-A108	T _{sp} =105°C, G & R 2 channel on	160mA	1000 hours	0/22
8	High Temperature Operating Life	JESD22-A108	T _{sp} =85°C, B channel on	160mA	1000 hours	0/22
9	Thermal Shock	JESD22-A104	T _a =-40°C ~100°C, Dwell : 15min; Transfer: 10sec		200 Cycles	0/22
10	Temperature Cycle	JESD22-A104	T _a =-40°C ~100°C, Dwell at extreme temperature: 15min; Ramp rate < 105°C/min		200 Cycles	0/22

Passing Criteria

Item	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	120mA	ΔVf<10%
Luminous Flux	lv	120mA	ΔΙν<30%
Chromaticity Coordinates	(x, y)	120mA	Δu'v'<0.007

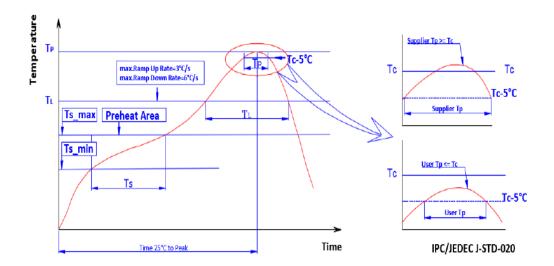
Notes for Table 16:

^{1.} Measurements are performed after allowing the LEDs to return to room temperature

^{2.} T_{sld} : reflow soldering temperature; T_{a} : ambient temperature

Reflowing Characteristics

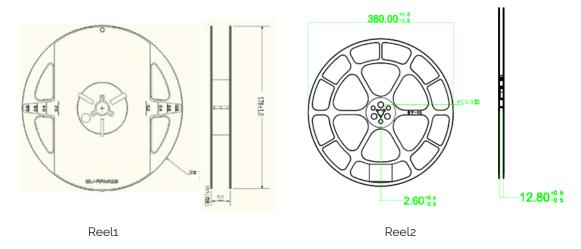
Figure 12: Reflow Profile



Profile Feature	Lead Free Assembly	
Temperature Min. (Ts_min)	160°C	
Temperature Max. (Ts_max)	205°C	
Time (ts) from Ts_min to Ts_max	60-150 seconds	
Ramp-Up Rate (TL to Tp)	3 °C/second	
Liquidus Temperature (TL)	220 °C	
Time (TL) Maintained Above TL	60-150 seconds	
Peak Temp(Tp)	260 °C max.	
Time (Tp) Within 5 $^{\circ}\text{C}$ of the Specified Classification Temperature (Tc)	25 seconds max.	
Ramp-Down Rate (Tp to TL)	5 °C/second max.	
Time 25 °C to Peak Temperature	10 minutes max.	

Packaging

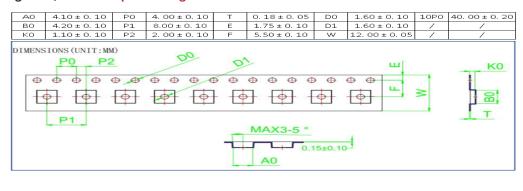
Figure 13: Emitter Reel Drawings

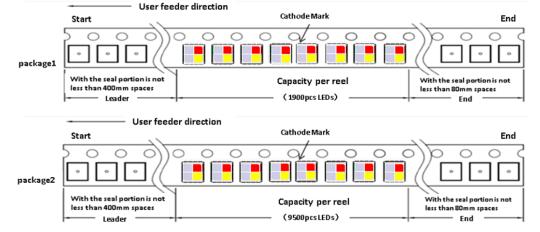


Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Emitter Tape Drawings



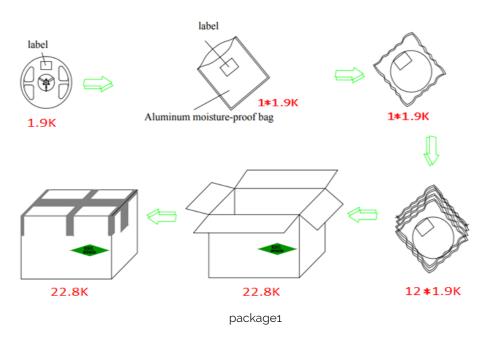


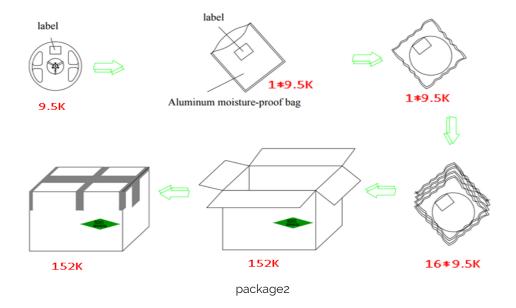
Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 15: Emitter Reel Packaging Drawings





Note for Figure 15:

1. Drawings are not to scale. Package2 is used as the standard for normal shipment,

Design Resources

Optical Source Models

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux SMD LED emitter is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. Please use appropriate precautions when the blue light is on since blue light poses eye safety risk. The Blue is classified as Risk Group 2 when operated at or below the maximum drive current. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES. Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES .

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: Bridging Light and Life™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

For more information about the company, please visit bridgelux.com twitter.com/Bridgelux facebook.com/Bridgelux WeChat ID: BridgeluxInChina



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